

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

## SSM3K16FU

High Speed Switching Applications

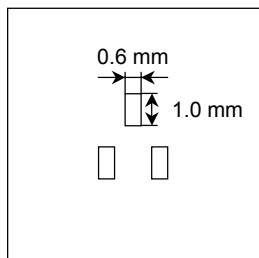
Analog Switching Applications

- Suitable for high-density mounting due to compact package
- Low on resistance:  $R_{on} = 3.0 \Omega$  (max) (@ $V_{GS} = 4 V$ )  
 :  $R_{on} = 4.0 \Omega$  (max) (@ $V_{GS} = 2.5 V$ )  
 :  $R_{on} = 15 \Omega$  (max) (@ $V_{GS} = 1.5 V$ )

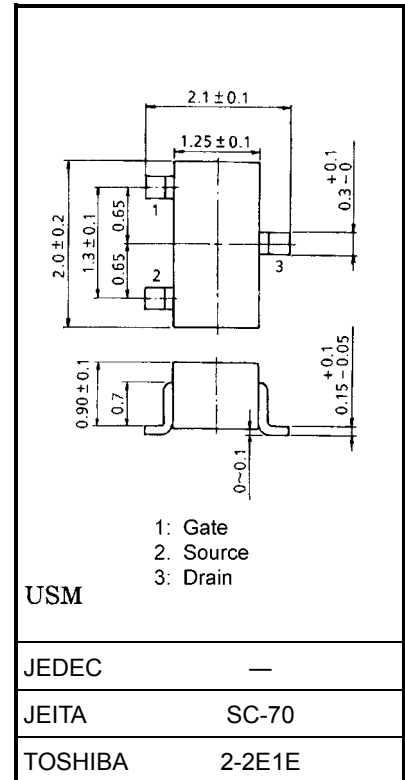
### Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-Source voltage	$V_{DS}$	20	V
Gate-Source voltage	$V_{GSS}$	$\pm 10$	V
Drain current	DC	$I_D$	100
	Pulse	$I_{DP}$	200
Drain power dissipation (Ta = 25°C)	$P_D$ (Note)	150	mW
Channel temperature	$T_{ch}$	150	°C
Storage temperature range	$T_{stg}$	-55~150	°C

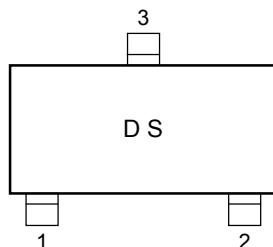
Note: Mounted on FR4 board  
 (25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6 mm<sup>2</sup> × 3)



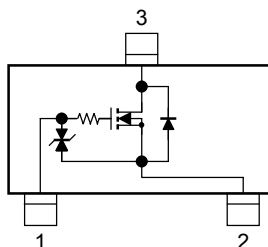
Unit: mm



### Marking



### Equivalent Circuit



### Handling Precaution

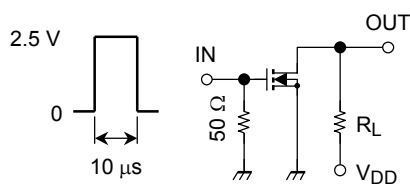
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

## Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 10\text{ V}, V_{DS} = 0$	—	—	$\pm 1$	$\mu\text{A}$
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = 0.1\text{ mA}, V_{GS} = 0$	20	—	—	V
Drain cut-off current	$I_{DSS}$	$V_{DS} = 20\text{ V}, V_{GS} = 0$	—	—	1	$\mu\text{A}$
Gate threshold voltage	$V_{th}$	$V_{DS} = 3\text{ V}, I_D = 0.1\text{ mA}$	0.6	—	1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3\text{ V}, I_D = 10\text{ mA}$	40	—	—	mS
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = 10\text{ mA}, V_{GS} = 4\text{ V}$	—	1.5	3.0	$\Omega$
		$I_D = 10\text{ mA}, V_{GS} = 2.5\text{ V}$	—	2.2	4.0	
		$I_D = 1\text{ mA}, V_{GS} = 1.5\text{ V}$	—	5.2	15	
Input capacitance	$C_{iss}$	$V_{DS} = 3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	9.3	—	pF
Reverse transfer capacitance	$C_{rss}$	$V_{DS} = 3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	4.5	—	pF
Output capacitance	$C_{oss}$	$V_{DS} = 3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	9.8	—	pF
Switching time	Turn-on time	$t_{on}$	—	70	—	ns
	Turn-off time	$t_{off}$		125		

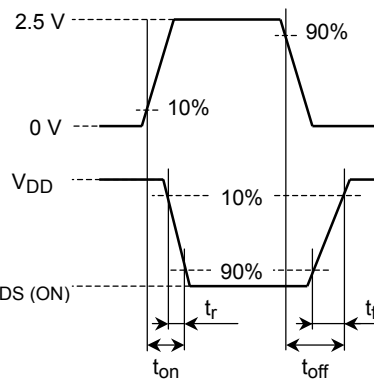
## Switching Time Test Circuit

### (a) Test circuit

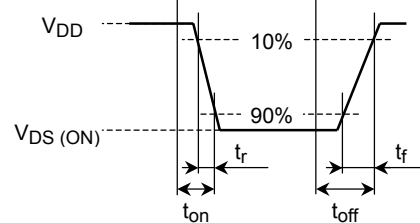


$V_{DD} = 3\text{ V}$   
 Duty  $\leq 1\%$   
 $V_{IN}$ :  $t_r, t_f < 5\text{ ns}$   
 $(Z_{out} = 50\ \Omega)$   
 Common Source  
 $T_a = 25^\circ\text{C}$

### (b) $V_{IN}$



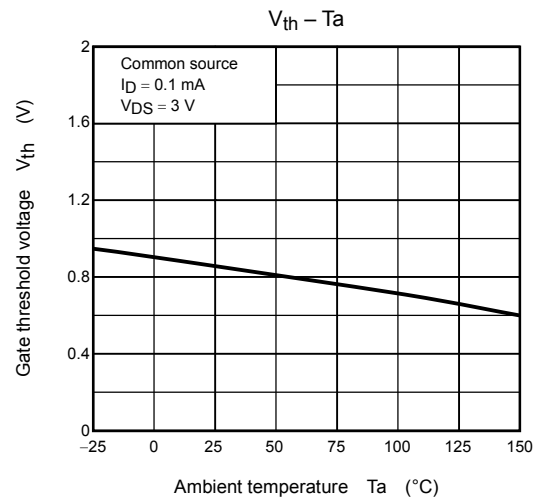
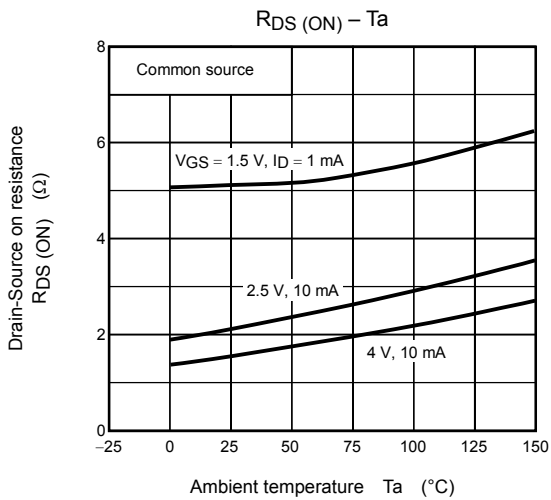
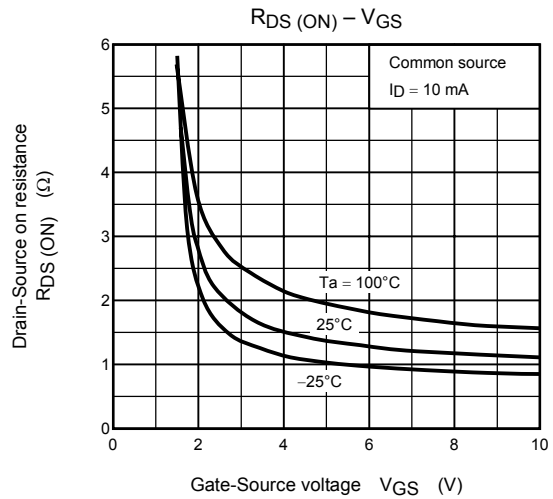
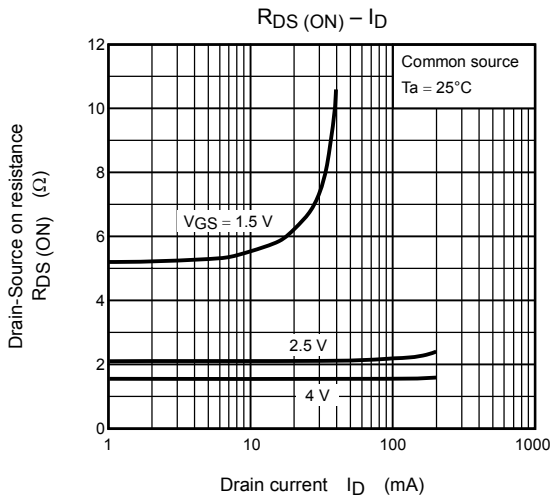
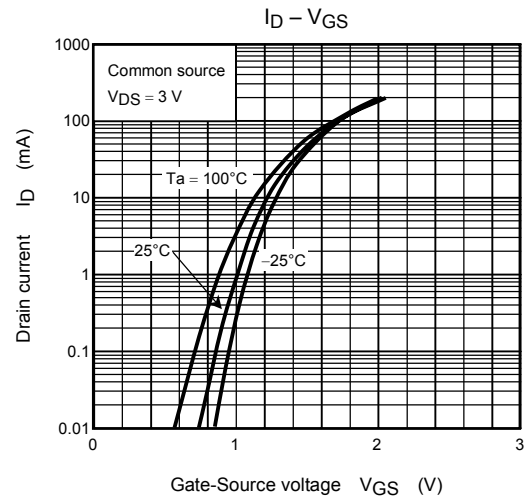
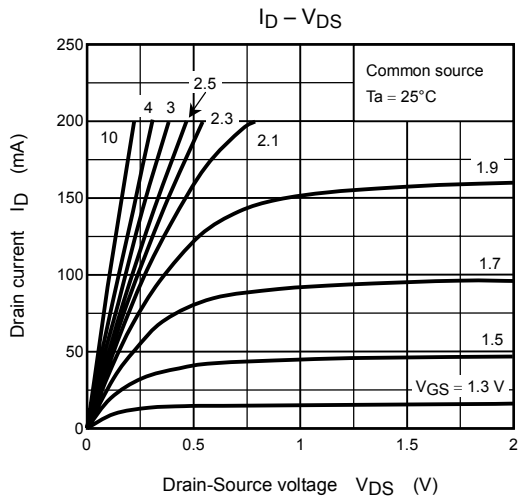
### (c) $V_{OUT}$

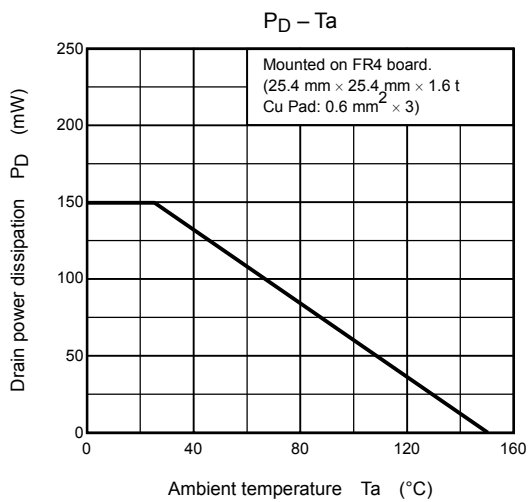
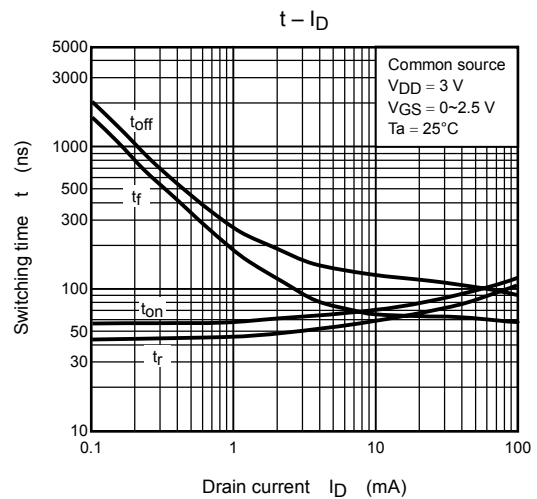
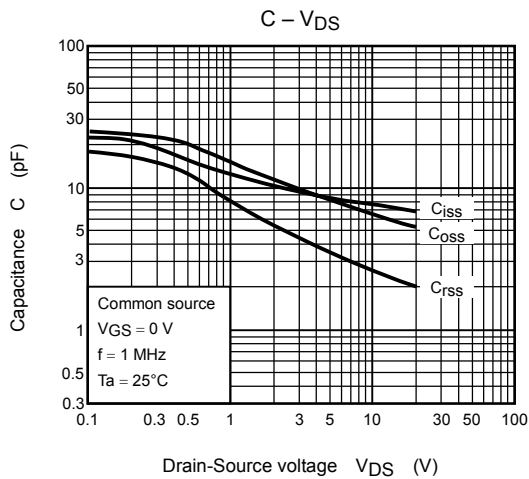
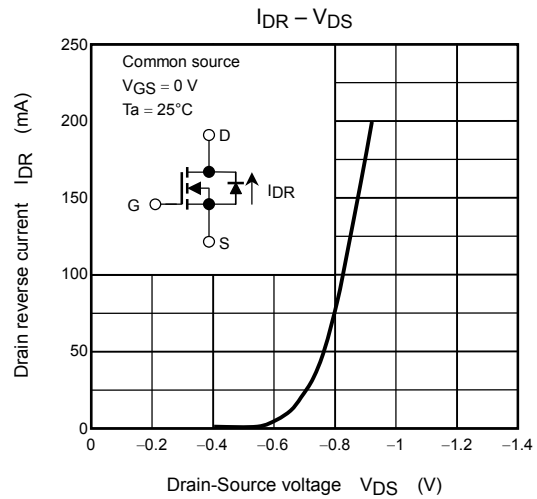
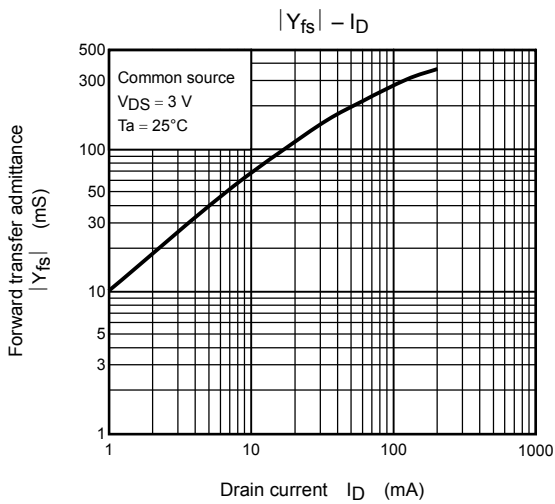


## Precaution

$V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D = 100\ \mu\text{A}$  for this product. For normal switching operation,  $V_{GS(ON)}$  requires higher voltage than  $V_{th}$  and  $V_{GS(OFF)}$  requires lower voltage than  $V_{th}$ . (Relationship can be established as follows:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ )

Please take this into consideration for using the device.  $V_{GS}$  recommended voltage of 1.5 V or higher to turn on this product.





**RESTRICTIONS ON PRODUCT USE**

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